

## **ICMDA 2026**

Tohoku University, Sendai, Japan April 17-20, 2026

### **Call for Paper**

Topics of interest for submission include, but are not limited to:

# Materials Properties, Measuring Methods and Applications:

- Ductility
- Crack Resistance
- Fatigue
- Creep-resistance

## Materials Science and Materials Processing Technology:

- Composite
- Micro/Nano materials
- Iron & Steel
- Ceramics

#### **Materials Analyses and Modeling:**

- Electron Microscopy
- Image Analysis
- X-ray Phase Analysis
- Computational Material Science

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### **Contact US**

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## **Proceedings**

Accepted and registered papers with presentation will be published in journals of <u>Scientific.Net</u> collection. Papers will be sent for indexing by **Scopus**, Inspec, Chemical Abstracts Service, Google Scholar etc.

## **Conference Committees**

#### **Conference Chairs**

- Osamu Tabata, Kyoto University of Advanced Science, Japan
- Takashige Omatsu, Chiba University, Japan

#### **Local Chair**

• Tomoya Oshikiri, Tohoku University, Japan

#### **Program Chairs**

- Masahiro Nomura, The University of Tokyo, Japan
- Kwang Leong Choy, Duke Kunshan University, China

More Commitees: https://icmda.org/com.html

## **Speakers**



Dr. Adrian Radoń, Center of Functional Materials, Łukasiewicz Research Network – Institute of Non-Ferrous Metals, Poland

Prof. Lung-Hao Hu, National Sun Yat-sen University (NSYSU), Taiwan



Coming More.....

## **Important Date**

Submission Deadline: **Nov. 25, 2025**Notification Deadline: **Dec. 20, 2025**Registration Deadline: **Jan. 10, 2026**